

### N-Channel 30-V (D-S) MOSFET

#### **CHARACTERISTICS**

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

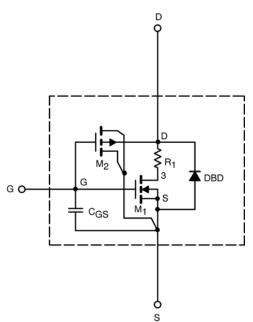
- Apply for both Linear and Switching Application
- Accurate over the –55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

#### DESCRIPTION

The attached spice model describes the typical electrical characteristics of the n-channel vertical DMOS. The subcircuit model is extracted and optimized over the -55 to  $125^{\circ}$ C temperature ranges under the pulsed 0-V to 4.5-V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

#### SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

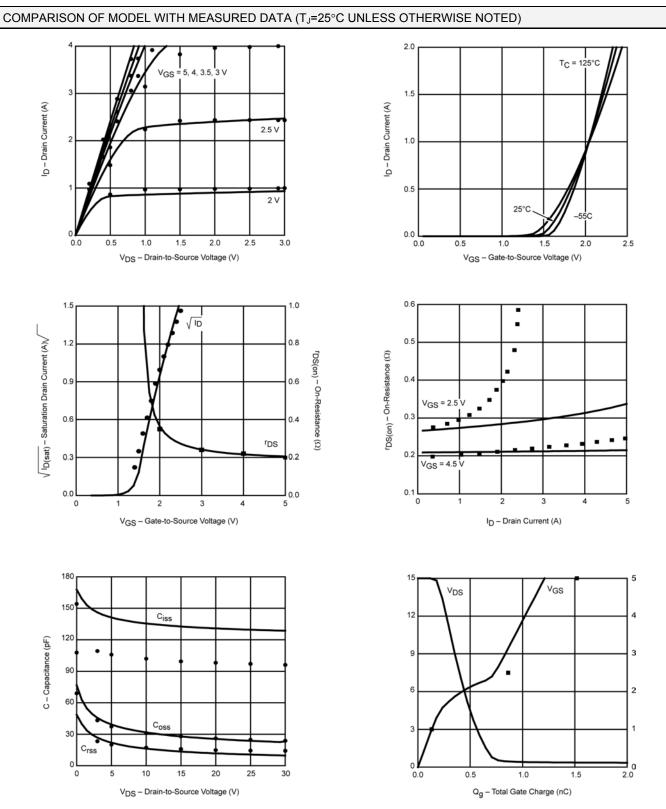


Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static			•		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.1		V
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{\text{DS}} \geq 5$ V, $V_{\text{GS}}$ = 4.5 V	12		А
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS}$ = 4.5 V, I <sub>D</sub> = 0.9 A	0.21	0.216	Ω
		$V_{GS}$ = 2.5 V, I <sub>D</sub> = 0.75 A	0.30	0.308	
Forward Transconductance <sup>a</sup>	<b>g</b> <sub>fs</sub>	$V_{DS}$ = 15 V, I <sub>D</sub> = 0.9 A	3	2	S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 0.28 A	0.78	0.80	V
Dynamic <sup>b</sup>	-			-	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	132	100	pF
Output Capacitance	C <sub>oss</sub>		28	30	
Reverse Transfer Capacitance	C <sub>rss</sub>		14	20	
Total Gate Charge	Qg	$V_{\text{DS}}$ = 15 V, $V_{\text{GS}}$ = 4.5 V, $I_{\text{D}}$ = 0.9 A	1.2	1.8	nC
		$V_{DS}$ = 15 V, $V_{GS}$ = 2.5 V, $I_{D}$ = 0.9 A	0.8	1.1	
Gate-Source Charge	Q <sub>gs</sub>		0.4	0.4	
Gate-Drain Charge	Q <sub>gd</sub>		0.6	0.6	

Notes a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2%. b. Guaranteed by design, not subject to production testing.



# SPICE Device Model Si1304BDL Vishay Siliconix



Note: Dots and squares represent measured data.



Vishay

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